A High-Efficiency SiGe BiCMOS WCDMA Power Amplifier with Dynamic Current Biasing for Improved Average Efficiency

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Abstract — This paper demonstrates a WCDMA single-stage power amplifier fabricated in a 0.25µm SiGe BiCMOS process. With dynamic biasing of the collector current, the average power efficiency is improved by more than a factor of two compared to a typical class AB power amplifier. The power amplifier satisfies the 3GPP Class-III WCDMA Adjacent Channel Power Ratio (ACPR) specifications (ACPR_{5MHz}=33dBc and ACPR_{10MHz}=58.8dBc) with 23.9dBm average channel output power. The measured output power at the 1dB compression point is 25.9dBm.

Index Terms — Silicon Germanium, power amplifiers, WCDMA, average power efficiency, dynamic biasing.

I. INTRODUCTION

In recent years, Silicon Germanium (SiGe) has become a competitive candidate for the development of handset power amplifiers (PAs), since SiGe exhibits high efficiency, good linearity, high current gain, low-cost and compatibility with BiCMOS technology [1]. For WCDMA PA’s, linearity and efficiency are the most critical design parameters. Moreover, average power efficiency (over the full range of output powers), instead of peak power efficiency, is the key factor determining the talk time and battery lifetime for portable wireless applications [2]. Previous efforts using dynamic biasing techniques [3]-[5] did achieve improved average power efficiency, but their power gains changed dramatically when switched from the high-power region to the low-power region, which can create problems in the power control loop operation of the CDMA handset. For Class-III WCDMA handsets, +24dBm maximum output power (+1/3dB tolerance) and -33dBc ACPR at the highest output power are required [6]. Besides satisfying the above specifications, our approach may substantially increase the average power efficiency, while keeping the power gain roughly constant.

The principle of dynamic current biasing is introduced in Section II, and the detailed design approach is discussed in Section III. Measurement results are shown in Section IV.

II. DYNAMIC CURRENT BIASING

A. Average Power Efficiency

The average power efficiency is a measure of the ratio of the total energy transmitted to the total energy drawn from the battery [2], i.e.,

\[
\frac{\left\langle \eta \right\rangle}{\left\langle \frac{P_{out}}{P_{in}} \right\rangle} = \frac{\int P_{out} p(P_{out}) dP_{out}}{\int P_{in} p(P_{in}) dP_{in} / \eta(P_{in})}.
\] (1)

Where \( P_{out} \) is the output power, \( p(P_{out}) \) is the power-added efficiency at \( P_{out} \). The average output power of a CDMA handset is well below the peak output power, where efficiency is a maximum, so it is very desirable to improve the PAE of the amplifier at lower output powers. For ideal Class-A power amplifiers, the average power efficiency (over representative CDMA conditions) is roughly 1.3% [7]. Therefore, improving average power efficiency is one of the key objectives for future power amplifiers.

B. Dynamic Current Biasing

The typical approaches for reducing dc power consumption at lower output powers are reducing either DC bias current through dynamic current biasing (DCB) or DC bias voltage (DVB) (as shown in Fig. 1) or both.

Power amplifiers with dynamic current biasing (DCB) have been proposed [31]-[41], but their power gain changes by more than 10 dB over the range of current variation. With the decrease of input power, the current swing at the output also becomes smaller and the total bias current can be reduced. However the current density of each transistor drops, resulting in a power gain reduction for the whole power amplifier circuitry. The power gain of the amplifier (including the effects of source impedance and load impedance) is:

\[
G_p = \frac{4R_2}{\left( R_S + \frac{\omega L}{\omega} \right)^2} \left( \frac{\omega L}{\omega} \right) \frac{R_2}{1 + \omega L C_p R}.
\] (2)
Where $R_s$ is the source impedance, $r_i$ is the base resistance, and $f_t$ is the unity current gain radian frequency. This illustrates the need to keep the current density of the transistor roughly constant (and hence the $r_i$ constant) even as the current is lowered.

![Fig. 1 BJT current versus voltage, demonstrating different dynamic biasing strategies (DCOVB: dynamic current/voltage biasing).](image)

To lower the collector current and keep the power gain roughly constant, we utilize low-loss MOS switches to dynamically bias the SiGe HBTs [8], as depicted in Fig. 2.

![Fig. 2 Output stage with dynamic current biasing. HBTs are biased "on" or "off" in response to output power requirements.](image)

The number of "on" transistors is adjusted in response to changes in the output power; the collector current density increases slightly at the low power region so as to keep power gain constant. As shown in Fig. 3, the power amplifier shifts to a higher transition frequency (f1) in low power mode, nevertheless it operates at a lower transition frequency (f12) in high power mode. Operating the transistor at higher transition frequency enables us to keep the gain relatively constant by overcoming the effects of the extra parasitics in low power mode.

![Fig. 3 Simulated HBT cutoff frequency versus collector current with differing device sizes (single device: 25μm²; m represents the number of devices in parallel).](image)

**III. DESIGN CONSIDERATIONS**

Ideally, the dc bias current would change continuously in response to the input power, but it is simpler to vary the current in discrete steps. Simulation results show that a single step variation in dc bias provides the best tradeoff of average power efficiency and circuit complexity. In our case, the high power mode consisted of 100 parallel devices, and the low-power mode consisted of 20 devices. Each bipolar transistor emitter is 0.44μm by 48μm.

The simplified equivalent input circuit is shown in Fig. 4. The NFET switches at the bases of transistors will reduce the power gain. The gain loss can be expressed as:

$$\Delta \text{Gain} = \Delta \text{Gain}_{R_{\text{mos}}} + \Delta \text{Gain}_{C_{\text{mos}}}$$

$$= 10 \log \frac{R_s^2}{(R_{\text{mos}} + R_i)^2}.$$  \hspace{1cm} (3a)

![Fig. 4 Equivalent input circuit. For 100 parallel devices, $R_{\text{mos}}=0.3\Omega$, $C_{\text{mos}}=3.26pF$, $R_i=10\Omega$, and $C_{in}=204pF$.](image)

The effects of the NFET switch size on both power gain and 1dB compression point of the power amplifier were simulated. The results are shown in Fig. 5. There are two sources for power loss: series resistance loss and shunt capacitance loss. Based on the simulation results that match the expression in (3b), an optimum MOS switch size of 3 finger $\times$ 15μm $\times$ 0.26μm was chosen. The corresponding gain loss at 1.95GHz was 2.5dB.

The bias network consists of a $\beta$ helper and a low impedance buffer, as shown in Fig. 6. This topology
provides a constant voltage biasing to the base of the power amplifier and also terminates the sub-harmonic (Δω) frequency at the input, to improve the overall linearity [9]. In order to effectively terminate the sub-harmonic component, the buffer needs to satisfy certain bandwidth requirements. For WCDMA handset power amplifiers, the channel bandwidth is 3.84MHz, so the minimum bandwidth of the bias network has to be larger than 3.84MHz. Simulation shows $Z_{bias}(\Delta \omega) = 0, \Delta \omega \leq 5 \text{MHz}$.

Fig. 5 Effects of gate finger on Gain and 1dB compression. Each finger is 15μm x 2.5μm and the HBT is 0.64μm by 48μm.

Fig. 6 Power amplifier bias schematic.

IV. MEASUREMENT RESULTS

The single-stage power amplifier was fabricated in the 0.25μm IBM BICMOS 6HP process [10]. The chip size, including the bias network, is 0.9mm x 1.2mm. The die photograph is shown in Fig. 7. The devices were tested in Micro Lead Frame (MLF12) packages. The output matching network (OMN) is implemented off-chip to achieve high Q for optimum PAE.

Fig. 8 compares the measured DC currents for different biasing approaches for a single-stage WCDMA power amplifier, superimposed on a typical probability distribution function for the output power [2]. These approaches include constant base voltage (CV) biasing with a fixed number of parallel transistors and DCB with a fixed base voltage. Using (1), average power efficiencies are calculated as 2.5% for CV biasing and 8.0% for DCB—a substantial improvement with the new approach.

Fig. 7 Photo of DCB SiGe HBT power amplifier die.

Fig. 9 compares the measured gain variation between DCB and CV. The gain change for DCB is less than 2dB, and is much more constant than DCB where the number of HBTs is fixed and the current density per device is reduced to vary the current.

The linearity of the DCB amplifier is measured for a WCDMA signal in Fig. 10, and the circuit satisfies the 3GPP Class-III WCDMA ACPR specification with 23.9dBm channel output power.

Fig. 11 shows measured power added efficiencies (PAEs) with DCB and CV approaches. The peak PAE is not as high as other III-V WCDMA amplifiers reported [11], but the average power efficiency is improved, based on DC current data given for those amplifiers.

Fig. 8 Output power probability distribution $P_e$ and measured DC current comparison for different biasing techniques. The switch point from 100 devices to 20 devices occurs at $P_{out} = 18 \text{ dBm}, V_{ce} = 3 \text{V}$.

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An integrated single-stage power amplifier chip with dynamic current biasing for WCDMA applications was fabricated and measured. The measured 1dB compression point is 25.9dBm, and peak PAE is 31%. The average power efficiency is improved from 2.5% to 8.0%. The power amplifier satisfies the ACPR specification for uplink with 23.9dBm channel output power.

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REFERENCES